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NO. 3449 P. 3/7

MAY 18 2006

Docket No.: YOR9200030587US1
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Cyril Cabral, Jr. et al.

Application No.: 10/714,966

Confirmation No.: 4605

Filed: November 18, 2003

Art Unit: 2811

For: ELECTROPLATED COWP COMPOSITES
STRUCTURES AS COPPER BARRIER
LAYERS

Examiner: H. K. Vu

Please Enter.
Vu

SUPPLEMENTAL AMENDMENT TO FINAL OFFICE ACTION

MS AF Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Final Office Action dated April 7, 2006, and subsequent Amendment to Final Office Action filed April 25, 2006, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.